

# Converter - Brake - Inverter Module (CBI 1)

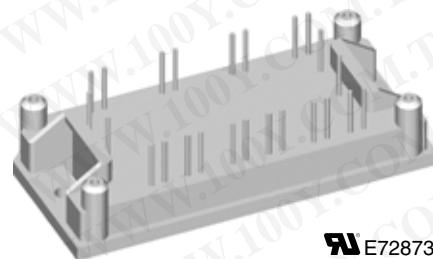
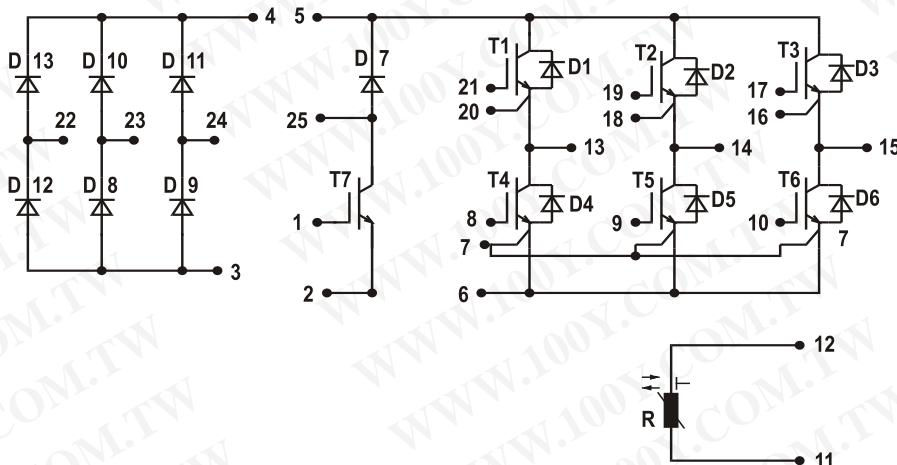
## NPT IGBT

Preliminary data

**Part name** (Marking on product)

MUBW10-06A6K

Three Phase Rectifier	Brake Chopper	Three Phase Inverter
$V_{RRM} = 1600 \text{ V}$	$V_{CES} = 600 \text{ V}$	$V_{CES} = 600 \text{ V}$
$I_{DAVM25} = 90 \text{ A}$	$I_{C25} = 12 \text{ A}$	$I_{C25} = 52 \text{ A}$
$I_{FSM} = 300 \text{ A}$	$V_{CE(sat)} = 2.5 \text{ V}$	$V_{CE(sat)} = 2.5 \text{ V}$



E72873

Pin configuration see outlines.

### Features:

- High level of integration - only one power semiconductor module required for the whole drive
- Inverter with NPT IGBTs
- low saturation voltage
- positive temperature coefficient
- fast switching
- short tail current
- Epitaxial free wheeling diodes with hiperfast and soft reverse recovery
- Industry standard package with insulated copper base plate and soldering pins for PCB mounting
- Temperature sense included

### Application:

- AC motor drives with
- Input from single or three phase grid
- Three phase synchronous or asynchronous motor
- Electric braking operation

### Package:

- UL registered
- Industry standard E1-pack

**Output Inverter T1 - T6**

**Ratings**

Symbol	Definitions	Conditions	min.	typ.	max.	Unit
$V_{CES}$	collector emitter voltage	$T_{VJ} = 25^\circ\text{C}$ to $150^\circ\text{C}$			600	V
$V_{GES}$	max. DC gate voltage	continuous			$\pm 20$	V
$V_{GEM}$	max. transient collector gate voltage	transient			$\pm 30$	V
$I_{C25}$	collector current	$T_C = 25^\circ\text{C}$	11		A	
$I_{C80}$		$T_C = 80^\circ\text{C}$	8		A	
$P_{tot}$	total power dissipation	$T_C = 25^\circ\text{C}$		50		W
$V_{CE(sat)}$	collector emitter saturation voltage	$I_C = 10 \text{ A}; V_{GE} = 15 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	2.7 3.1	3.3	V
$V_{GE(th)}$	gate emitter threshold voltage	$I_C = 0.2 \text{ mA}; V_{GE} = V_{CE}$	$T_{VJ} = 25^\circ\text{C}$	4.5	6.5	V
$I_{CES}$	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$		65	$\mu\text{A}$
$I_{GES}$	gate emitter leakage current	$V_{CE} = 0 \text{ V}; V_{GE} = \pm 20 \text{ V}$			120	nA
$C_{ies}$	input capacitance	$V_{CE} = 25 \text{ V}; V_{GE} = 0 \text{ V}; f = 1 \text{ MHz}$		220		pF
$Q_{G(on)}$	total gate charge	$V_{CE} = 300 \text{ V}; V_{GE} = 15 \text{ V}; I_C = 6 \text{ A}$		32		nC
$t_{d(on)}$	turn-on delay time	$\left. \begin{array}{l} t_r \\ t_{d(off)} \\ t_f \\ E_{on} \\ E_{off} \end{array} \right\}$ inductive load $V_{CE} = 300 \text{ V}; I_C = 6 \text{ A}$ $V_{GE} = \pm 15 \text{ V}; R_G = 54 \Omega$	$T_{VJ} = 125^\circ\text{C}$	20		ns
$t_r$	current rise time			10		ns
$t_{d(off)}$	turn-off delay time			110		ns
$t_f$	current fall time			30		ns
$E_{on}$	turn-on energy per pulse			0.22		mJ
$E_{off}$	turn-off energy per pulse			0.26		mJ
$I_{CM}$	reverse bias safe operating area	$RBSOA; V_{GE} = \pm 15 \text{ V}; R_G = 54 \Omega$ $L = 100 \mu\text{H}; \text{clamped induct. load}$ $V_{CEmax} = V_{CES} - L_s \cdot di/dt$	$T_{VJ} = 125^\circ\text{C}$	18		A
$t_{sc}$ (SCSOA)	short circuit safe operating area	$V_{CE} = 600 \text{ V}; V_{GE} = \pm 15 \text{ V}; R_G = 54 \Omega; \text{non-repetitive}$	$T_{VJ} = 125^\circ\text{C}$	10		$\mu\text{s}$
$R_{thJC}$	thermal resistance junction to case	(per IGBT)			2.75	K/W
$R_{thCH}$	thermal resistance case to heatsink	(per IGBT)		0.95		K/W

**Output Inverter D1 - D6**

**Ratings**

Symbol	Definitions	Conditions	min.	typ.	max.	Unit
$V_{RRM}$	max. repetitive reverse voltage	$T_{VJ} = 150^\circ\text{C}$		600		V
$I_{F25}$	forward current	$T_C = 25^\circ\text{C}$		21		A
$I_{F80}$		$T_C = 80^\circ\text{C}$		14		A
$V_F$	forward voltage	$I_F = 10 \text{ A}; V_{GE} = 0 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$		2.2 1.6	V
$I_{RM}$	max. reverse recovery current	$\left. \begin{array}{l} t_{rr} \\ E_{rec(off)} \end{array} \right\}$ $V_R = 100 \text{ V}$ $di_F/dt = -100 \text{ A}/\mu\text{s}$ $I_F = 12 \text{ A}; V_{GE} = 0 \text{ V}$	$T_{VJ} = 100^\circ\text{C}$	4.4		A
$t_{rr}$	reverse recovery time			80		ns
$E_{rec(off)}$	reverse recovery energy			tbd		$\mu\text{J}$
$R_{thJC}$	thermal resistance junction to case	(per diode)			2.5	K/W
$R_{thCH}$	thermal resistance case to heatsink	(per diode)		0.85		K/W

$T_C = 25^\circ\text{C}$  unless otherwise stated



勝特力材料 886-3-5753170  
 胜特力电子(上海) 86-21-34970699  
 胜特力电子(深圳) 86-755-83298787  
[Http://www.100y.com.tw](http://www.100y.com.tw)

MUBW10-06A6K

### Brake Chopper T7

#### Ratings

Symbol	Definitions	Conditions	min.	typ.	max.	Unit
$V_{CES}$	collector emitter voltage	$T_{VJ} = 25^\circ\text{C}$ to $150^\circ\text{C}$			600	V
$V_{GES}$	max. DC gate voltage	continuous			$\pm 20$	V
$V_{GEM}$	max. transient collector gate voltage	transient			$\pm 30$	V
$I_{C25}$	collector current	$T_C = 25^\circ\text{C}$	11		A	
$I_{C80}$		$T_C = 80^\circ\text{C}$	8		A	
$P_{tot}$	total power dissipation	$T_C = 25^\circ\text{C}$			50	W
$V_{CE(sat)}$	collector emitter saturation voltage	$I_C = 10 \text{ A}; V_{GE} = 15 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	2.65 3.1	3.3	V
$V_{GE(th)}$	gate emitter threshold voltage	$I_C = 0.2 \text{ mA}; V_{GE} = V_{CE}$	$T_{VJ} = 25^\circ\text{C}$	4.5	6.5	V
$I_{CES}$	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	0.7	0.1	mA mA
$I_{GES}$	gate emitter leakage current	$V_{CE} = 0 \text{ V}; V_{GE} = \pm 20 \text{ V}$			120	nA
$C_{ies}$	input capacitance	$V_{CE} = 25 \text{ V}; V_{GE} = 0 \text{ V}; f = 1 \text{ MHz}$		220		pF
$Q_{G(on)}$	total gate charge	$V_{CE} = 300 \text{ V}; V_{GE} = 15 \text{ V}; I_C = 6 \text{ A}$		32		nC
$t_{d(on)}$	turn-on delay time	$T_{VJ} = 125^\circ\text{C}$	20			ns
$t_r$	current rise time		10			ns
$t_{d(off)}$	turn-off delay time		110			ns
$t_f$	current fall time		30			ns
$E_{on}$	turn-on energy per pulse		0.21			mJ
$E_{off}$	turn-off energy per pulse		0.26			mJ
$I_{CM}$	reverse bias safe operating area	$RBSOA; V_{GE} = \pm 15 \text{ V}; R_G = 54 \Omega$ $L = 100 \mu\text{H}$ ; clamped induct. load $V_{CEmax} = V_{CES} - L \cdot di/dt$	$T_{VJ} = 125^\circ\text{C}$	18		A
$t_{sc}$ (SCSOA)	short circuit safe operating area	$V_{CE} = 600 \text{ V}; V_{GE} = \pm 15 \text{ V}; R_G = 54 \Omega$ ; non-repetitive	$T_{VJ} = 125^\circ\text{C}$	10		μs
$R_{thJC}$	thermal resistance junction to case	(per IGBT)			2.75	K/W
$R_{thCH}$	thermal resistance case to heatsink	(per IGBT)		0.9		K/W

### Brake Chopper D7

#### Ratings

Symbol	Definitions	Conditions	min.	typ.	max.	Unit
$V_{RRM}$	max. repetitive reverse voltage	$T_{VJ} = 150^\circ\text{C}$			600	V
$I_{F25}$	forward current	$T_C = 25^\circ\text{C}$	21		A	
$I_{F80}$		$T_C = 80^\circ\text{C}$	14		A	
$V_F$	forward voltage	$I_F = 10 \text{ A}; V_{GE} = 0 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	1.25	2.1	V V
$I_R$	reverse current	$V_R = V_{RRM}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	0.2	0.06	mA mA
$I_{RM}$	max. reverse recovery current	$V_R = 100 \text{ V}; I_F = 12 \text{ A}$ $di_F/dt = -100 \text{ A}/\mu\text{s}$	$T_{VJ} = 100^\circ\text{C}$	3.5		A
$t_{rr}$	reverse recovery time			80		ns
$R_{thJC}$	thermal resistance junction to case	(per diode)			2.5	K/W
$R_{thCH}$	thermal resistance case to heatsink	(per diode)		0.85		K/W

$T_C = 25^\circ\text{C}$  unless otherwise stated

IXYS reserves the right to change limits, test conditions and dimensions.

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### Input Rectifier Bridge D8 - D13

Symbol	Definitions	Conditions	Maximum Ratings		
$V_{RRM}$	max. repetitive reverse voltage			1600	V
$I_{FAV}$	average forward current	sine 180°	$T_c = 80^\circ\text{C}$	22	A
$I_{DAVM}$	max. average DC output current	rectangular; $d = \frac{1}{3}$ ; bridge	$T_c = 80^\circ\text{C}$	61	A
$I_{FSM}$	max. surge forward current	$t = 10 \text{ ms}; \text{sine } 50 \text{ Hz}$	$T_c = 25^\circ\text{C}$	300	A
$P_{tot}$	total power dissipation		$T_c = 25^\circ\text{C}$	50	W

### Symbol Conditions

Symbol	Conditions	Characteristic Values				
		min.	typ.	max.		
$V_F$	forward voltage	$I_F = 30 \text{ A}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	1.1 1.2	1.45	V
$I_R$	reverse current	$V_R = V_{RRM}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	0.3	0.01	mA
$R_{thJC}$	thermal resistance junction to case	(per diode)	$T_{VJ} = 25^\circ\text{C}$		2.1	K/W
$R_{thCH}$	thermal resistance case to heatsink	(per diode)		0.7		K/W

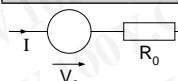
### Temperature Sensor NTC

Ratings					
Symbol	Definitions	Conditions	min.	typ.	max.
$R_{25}$	resistance		$T_c = 25^\circ\text{C}$	4.45	4.7
$B_{25/85}$				3510	5.0

### Module

Ratings					
Symbol	Definitions	Conditions	min.	typ.	max.
$T_{VJ}$	operating temperature		-40		150
$T_{VJM}$	max. virtual junction temperature				150
$T_{stg}$	storage temperature		-40		125
$V_{ISOL}$	isolation voltage	$I_{ISOL} \leq 1 \text{ mA}; 50/60 \text{ Hz}$			2500
$M_d$	mounting torque	(M4)	2.0		2.2
$d_s$	creep distance on surface		12.7		mm
$d_A$	strike distance through air		9.6		mm
Weight			40		g

### Equivalent Circuits for Simulation



Ratings					
Symbol	Definitions	Conditions	min.	typ.	max.
$V_0$	rectifier diode	D8 - D13	$T_{VJ} = 125^\circ\text{C}$	0.90	
$R_0$			12		$\text{m}\Omega$
$V_0$	IGBT	T1 - T6	$T_{VJ} = 125^\circ\text{C}$	1.4	
$R_0$			150		$\text{m}\Omega$
$V_0$	free wheeling diode	D1 - D6	$T_{VJ} = 125^\circ\text{C}$	1.25	
$R_0$			26		$\text{m}\Omega$
$V_0$	IGBT	T7	$T_{VJ} = 125^\circ\text{C}$	1.4	
$R_0$			150		$\text{m}\Omega$
$V_0$	free wheeling diode	D7	$T_{VJ} = 125^\circ\text{C}$	1.25	
$R_0$			26		$\text{m}\Omega$

$T_c = 25^\circ\text{C}$  unless otherwise stated

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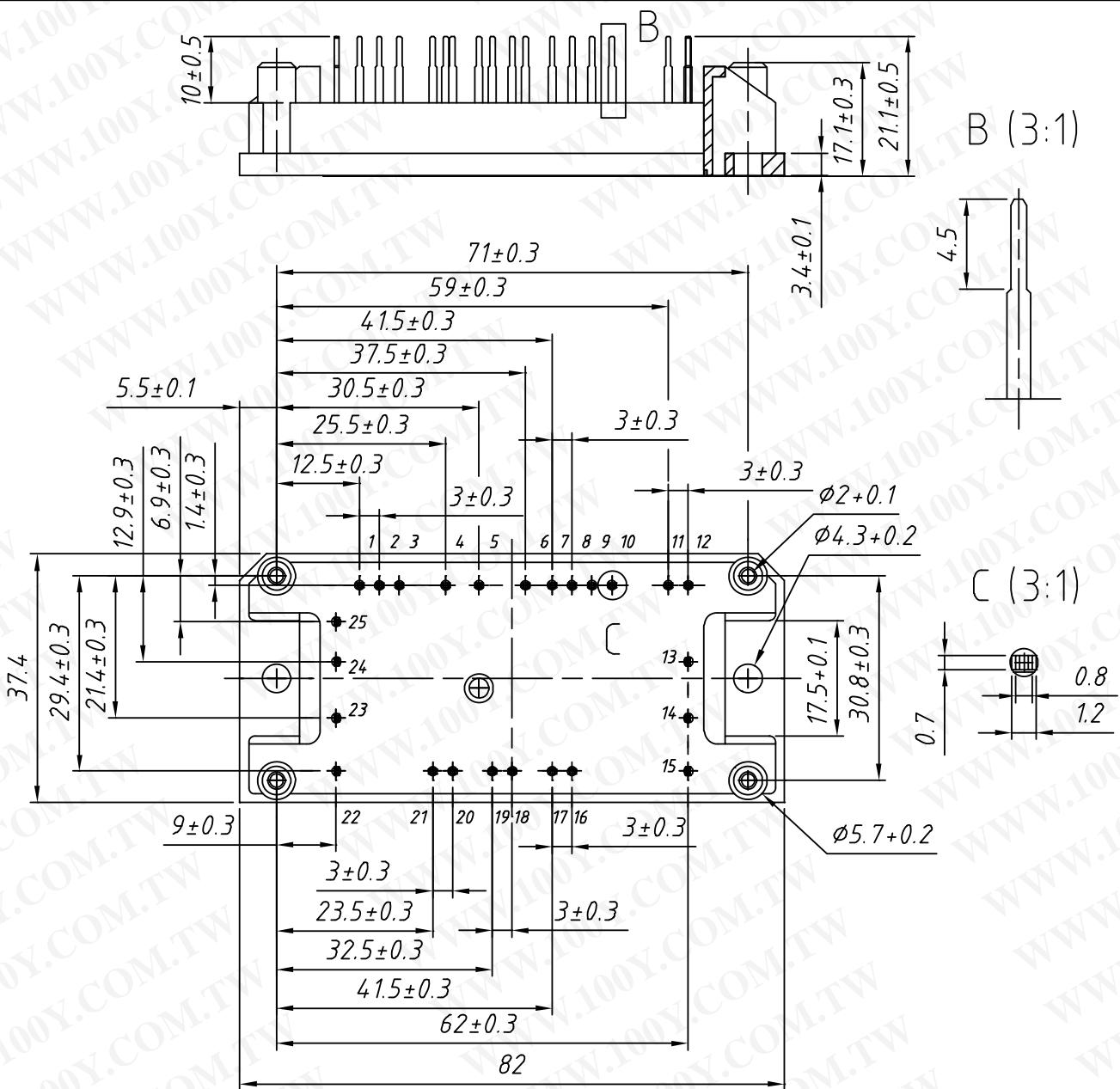
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## Outline Drawing

Dimensions in mm (1 mm = 0.0394")



## Product Marking

Ordering	Part Name	Marking on Product	Delivering Mode	Base Qty	Ordering Code
Standard	MUBW 10-06A6K	MUBW10-06A6K	Box	10	500 087